

AI Rugged Computer

COMPACT AI Rugged Vehicle Series

Computer Vision Edge Unit with NVIDIA Jetson AGX Xavier

LTE / GNSS / Wi-Fi



Dual nanoSIM
CFast
microSD
DisplayPort
USB

Image similar
RPC/RSLA3K22-D1025



DC supply

2 x CAN
M12 a-coded

2 x LAN
M12 x-coded

Digital
I/Os

RPC/COMPACT RSL A3 Series

This fanless RPC COMPACT-A3 generation is based on the NVIDIA Jetson AGX Xavier (Industrial) processor module and offers a wide range of highly integrated interface options. The ultra rugged and uncompromising design allows the use in the most demanding AI applications on mobile systems as well as in outdoor applications with harsh environmental conditions and guarantees long-term availability.

- 24/7 continuous operation
- Extended AI computing
- Wide temperature range -40°C ... $+70^{\circ}\text{C}$
- Sealed housing with IP67 / IP69 protection
- Shock and vibration resistant

 **NVIDIA**
Linux for Tegra (L4T)



Product Highlights

Ultra rugged
Sealed housing, protection class IP67 & IP69
Maintenance free
Power Ignition controller
No moving parts / passively cooled
Pressure equalization membrane
Resistance to chemicals
Long term availability (fixed BOM)

Product Features

AGX Xavier or AGX Xavier Industrial
512-core NVIDIA Volta™ GPU
with 64 Tensor Cores
8-Core ARM v8.2 64-bit NVIDIA Carmel CPU
32GB 256-Bit LPDDR4x RAM soldered on board
Storage options: NVMe M.2 2280 & CFast
Ethernet, USB, Passive or Active CAN
Rugged M12 connectors

Industries

Agriculture
Construction
Transportation
Off-Highway Vehicles
Heavy Industry
Autonomous Mobile Robots (AMRs)
Outdoor applications

Processor module / Performance

NVIDIA Jetson AGX Xavier (JAX) | 512-core NVIDIA Volta™ GPU with 64 Tensor Cores

8-Core ARM v8.2 64-bit NVIDIA Carmel CPU

AI Performance 32 TOPs 32 TOPs 32 TOPs

Memory / Storage

Data L3 Cache Size 4MB 4MB 4MB

256-Bit LPDDR4x RAM soldered on board 32GB 32GB 32GB

eMMC 5.1 Flash Storage on board 32GB 32GB 32GB

microSD Card socket 1 1 1

M.2 2280 Key M socket (for NVMe SSD)² 1 1 1CFast socket with retention frame² 1 1 1**Features**Real time clock (RTC) with battery backup^{Renata CR2477 (950 mAh)} • • •Inertial measurement unit (IMU)¹ STMicroelectronics ISM330DHCXTR on request on request on request**Communication Interfaces**Graphic interface^{behind the back service cover} DisplayPort 1.2 DisplayPort 1.2 DisplayPort 1.2Internal USB version 2.0 OTG^{behind the back service cover} (micro USB Type AB) 1 1 1USB version 2.0^{behind the back service cover} (Type A) 2 2 2

Ethernet 10/100/1000 Mbit BASE-T (M12 female x-coded) 2 2 2

CAN 2.0A / CAN 2.0B (active/passive), CAN FD supported, isolated (M12 female a-coded) 2 2 2

Power over Ethernet - IEEE802.3at 10/100/1000Mbit^{RMLA3 product} (M12 female x-coded) on request on request on request

USB version 2.0 (M12 female a-coded) on request on request none

Digital I/O's, 12/24VDC¹ (M12 male a-coded) on request on request 4 in & 2 outAnalog input¹, 0-20mA or -10...+10V / 0... 30V^(16bit resolution Accuracy: +/- 0.1%) (up to 4 inputs) on request on request noneMini PCIe socket² - used for extensions depending on configuration 1 full-size / 1 half-size 1 full-size / 1 half-size 1 full-size / 1 half-sizeI2C bus² 1 1 1**Wireless Connectivity**Cellular 4G Module (LTE/UMTS/GSM) with built-in GNSS⁶ Telit LE910C4-WWX (Dual nano SIM support) 3x SMA none noneWireless LAN IEEE 802.11a/b/g/n/ac dual-band 2x2 MIMO & Bluetooth 5.0⁶ Emwicon WMX6218 2x RP-SMA none noneHigh Accuracy GNSS Positioning Module w/ RTK support¹ u-blox ZED F9R / F9P on request none none

Cellular 5G Module (4G/3G fallback) with GNSS on request on request on request

Wireless LAN (Wi-Fi 6) 802.11ax/ac/a/b/g/n 2T2R on request on request on request

Technical Data

Dimensions mm (housing, excl. mounting) w250 x h75 x d170 w250 x h75 x d170 w250 x h75 x d170

Net weight in gram ~3050 ~3000 ~3050

Non isolated input voltage, with Ignition controller^{reverse polarity protected} (M12 5P male a-coded) 9 ... 45VDC 9 ... 45VDC 9 ... 45VDCPower consumption³ depends on power mode (15W, 30W, MAXN)**Environmental Conditions**Operating temperature³ -25°C ... +65°C -25°C ... +65°C -25°C ... +65°C

Storage temperature -25°C ... +80°C -25°C ... +80°C -25°C ... +80°C

Ingress protection standard according to EN60529 (ISO 20653) IP67 / IP69 IP67 / IP69 IP67 / IP69

Conformal coating⁴ on request on request on requestRoad vehicles, UN/ECE R10 (E-mark)⁵ on request on request on request

Agriculture ISOBUS hardware ready hardware ready hardware ready

Shock ISO 15003 / EN60068-2-64 (designed to meet) • • •

Vibration ISO 15003 / EN60068-2-64 (designed to meet) • • •

EMI-Conformity EN55032 / EN55035 EN55032 / EN55035 EN55032 / EN55035

Safety (designed to meet) EN62368-1 EN62368-1 EN62368-1

Radio and Telecommunication (designed to meet) RED RED RED

MTBF @ 25°C ambient^{according to Telcordia SR-332, Environment GB, excluding battery} ~325 000h ~435 000h ~400 000¹ Please contact factory for minimum order quantities² Internal connector³ Depending on installation situation, interface connection and power mode. Please see user documentation.⁴ On all possible components (excl. NVIDIA Xavier Module, connectors and wireless devices)⁵ UN/ECE-R10 is the type-approval test for European automotive electronics. It includes a variety of testing including RF immunity and emissions, transient immunity and emissions.⁶ These LTE and Wi-Fi modules have replaced the previously used Sierra Wireless MC7455 and SparkLAN WPEB-263ACNI(BT) due to these modules going EOL (previous products: RPC/RSLA3K22-B102S)

Product specifications subject to change without notice. | All data is for information purposes only and not guaranteed for legal purposes. Information in this data sheet has been carefully checked and is believed to be accurate. However, no responsibility is assumed for inaccuracies. Please refer to the user documentation for additional product specification.

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All rights reservedSyslogik Datentechnik AG
Täferstrasse 28
CH-5405 Baden Dättwil

Version 2.2 | January 2023

For further information and support:
info@syslogik.com
support@syslogik.com
www.syslogik.com+41 56 200 90 40 Switzerland (Headquarters)
+49 7741 9671-420 Germany and AustriaThe logo for Syslogik industrial computing, featuring a stylized red and white cube icon to the left of the text "syslogik" in a bold, sans-serif font, with "industrial computing" in a smaller font below it.

Processor module / Performance

NVIDIA Jetson AGX Xavier Industrial 512-Core NVIDIA Volta™ GPU (ECC) with 64 Tensor Cores 8-Core ARM v8.2 64-bit NVIDIA Carmel CPU	•	•	•
Dual Arm® Cortex®-R5 in lockstep (Safety Cluster Engine)	•	•	•
AI Performance (INT8)	30 TOPs	30 TOPs	30 TOPs

Memory / Storage

Data L3 Cache Size	4MB	4MB	4MB
QSPI NOR Flash Storage	64MB	64MB	64MB
256-Bit LPDDR4x ECC RAM soldered on board	32GB	32GB	32GB
eMMC 5.1 Flash Storage on board	64GB	64GB	64GB
microSD Card socket	1	1	1
M.2 2280 Key M socket (for NVMe SSD) ²	1	1	1
CFast socket with retention frame ²	1	1	1

Features

Real time clock (RTC) with battery backup	not possible	not possible	not possible
Inertial measurement unit (IMU) ¹ STMicroelectronics ISM330DHCXTR	on request	on request	on request

Communication Interfaces

Graphic interface <small>behind the back service cover</small>		DisplayPort 1.2	DisplayPort 1.2	DisplayPort 1.2
Internal USB version 2.0 OTG <small>behind the back service cover</small> (micro USB Type AB)		1	1	1
USB version 2.0 <small>behind the back service cover</small> (Type A)		2	2	2
Ethernet 10/100/1000 Mbit BASE-T (M12 female x-coded)		2	2	2
CAN 2.0A / CAN 2.0B (active/passive), CAN FD supported, isolated (M12 female a-coded)		2	2	2
Power over Ethernet - IEEE802.3at 10/100/1000Mbit <small>RMLA3 product</small> (M12 female x-coded)		on request	on request	on request
USB version 2.0 (M12 female a-coded)		on request	on request	none
Digital I/O's, 12/24VDC ¹ (M12 male a-coded)		on request	on request	4 in & 2 out
Analog input ¹ , 0-20mA or -10...+10V / 0... 30V <small>(16bit resolution Accuracy: +/- 0.1%)</small> (up to 4 inputs)		on request	on request	none
Mini PCIe socket ² - used for extensions depending on configuration		1 full-size / 1 half-size	1 full-size / 1 half-size	1 full-size / 1 half-size
I2C bus ²		1	1	1

choose one

Wireless Connectivity

Cellular 4G Module (LTE/UMTS/GSM) with built-in GNSS Telit LE910C4-WWX ⁶ (Dual nano SIM support)		3x SMA	none	none
Wireless LAN IEEE 802.11a/b/g/n/ac dual-band 2x2 MIMO & Bluetooth 5.0 Emwicon WMX6218 ⁶		2x RP-SMA	none	none
High Accuracy GNSS Positioning Module w/ RTK & optional heading support ¹ u-blox ZED F9R / F9P		on request	none	none
Cellular 5G Module (4G/3G fallback) with GNSS		on request	on request	on request
Wireless LAN (Wi-Fi 6) 802.11ax/ac/a/b/g/n 2T2R		on request	on request	on request

Technical Data

Dimensions mm (housing, excl. mounting)		w250 x h75 x d170	w250 x h75 x d170	w250 x h75 x d170
Net weight in gram		~ 3050	~ 3000	~ 3050
Non isolated input voltage, with Ignition controller <small>reverse polarity protected</small> (M12 5P male a-coded)		9 ... 45VDC	9 ... 45VDC	9 ... 45VDC
Power consumption ³		depends on power mode (15W, 30W, MAXN)		

Environmental Conditions

Operating temperature ³		-40°C ... +70°C	-40°C ... +70°C	-40°C ... +70°C
Storage temperature		-40°C ... +85°C	-40°C ... +85°C	-40°C ... +85°C
Ingress protection standard according to EN60529 (ISO 20653)		IP67 / IP69	IP67 / IP69	IP67 / IP69
Conformal coating ⁴		on request	on request	on request
Road vehicles, UN/ECE R10 (E-mark) ⁵		on request	on request	on request
Agriculture ISOBUS		hardware ready	hardware ready	hardware ready
Shock ISO 15003 / EN60068-2-64 (designed to meet)		•	•	•
Vibration ISO 15003 / EN60068-2-64 (designed to meet)		•	•	•
EMI-Conformity		EN55032 / EN55035	EN55032 / EN55035	EN55032 / EN55035
Safety (designed to meet)		EN62368-1	EN62368-1	EN62368-1
Radio and Telecommunication (designed to meet)		RED	RED	RED
MTBF @ 25°C ambient <small>according to Telcordia SR-332, Environment GB, excluding battery</small>		~ 315 000	~ 415 000	~ 380 000

¹ Please contact factory for minimum order quantities² Internal connector³ Depending on installation situation, interface connection and power mode. Please see user documentation.⁴ On all possible components (excl. NVIDIA Xavier Module, connectors and wireless devices)⁵ UN/ECE-R10 is the type-approval test for European automotive electronics. It includes a variety of testing including RF immunity and emissions, transient immunity and emissions.⁶ These LTE and Wi-Fi modules have replaced the previously used Sierra Wireless MC7455 and SparkLAN WPEB-263ACNI(BT) due to these modules going EOL (previous products: RPC/RMLA3K21-B102E)

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For further information and support:
info@syslogic.com
support@syslogic.com
www.syslogic.com

+41 56 200 90 40 Switzerland (Headquarters)
+49 7741 9671-420 Germany and Austria

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